



APPLICATIONS

- Battery-powered devices
- Portable devices
- Embedded computing
- High-current SMPS
- High-frequency SMPS
- POL converters
- FPGA

FEATURES

- Size 4.45mmx4.1mmx1.8mm
- Molded Construction
- Low Audible Noise
- Soft Saturation
- Stable Over High Temperatures
- Max Operating Temp +155°C
- RoHS/REACH-Compliant, Halogen-Free

ELECTRICAL CHARACTERISTICS

Parameter			Value	Unit
Inductance ⁽¹⁾	L	$\pm 20\%$	10	μ H
Resistance	R_{DC}	typ	163	m Ω
Resistance $_{MAX}$	$R_{DC MAX}$	max	215	m Ω
Rated Current ⁽²⁾	I_R	typ	1.9	A
Saturation Current $_{25^{\circ}C}$ ⁽³⁾	$I_{SAT 25^{\circ}C}$	typ	2	A
Saturation Current $_{100^{\circ}C}$ ⁽⁴⁾	$I_{SAT 100^{\circ}C}$	typ	2	A
Resonance Frequency	f_r	typ	16	MHz

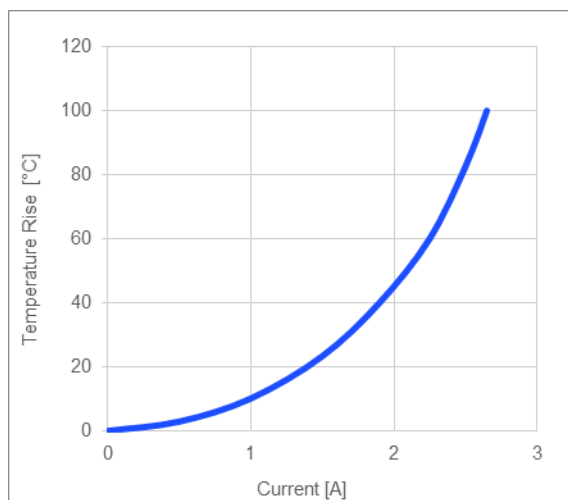
GENERAL SPECIFICATIONS

⁽¹⁾ Inductance	Measured at 100kHz, 100mA
⁽²⁾ Rated Current	Rated current will cause the coil temperature rise ΔT of 40K I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35 μ m Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.
⁽³⁾ Saturation Current $_{25^{\circ}C}$	Saturation current will cause L to drop from 30% at 25°C ambient temperature
⁽⁴⁾ Saturation Current $_{100^{\circ}C}$	Saturation current will cause L to drop from 30% at 100°C ambient temperature
Temperature Test Condition	Electrical specifications measured at 25°C, 35% RH if not given differently
Operating Condition	Operating temperature: -40°C to +155°C (including temp rise) Should not exceed +155°C under worst-case operation conditions
Storage Condition	Tape and Reel packaging: -10°C to +40°C Humidity: <50% RH

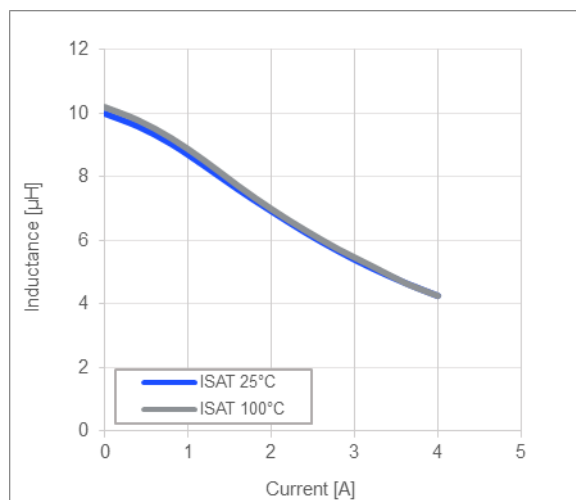
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TYPICAL PERFORMANCE CURVES

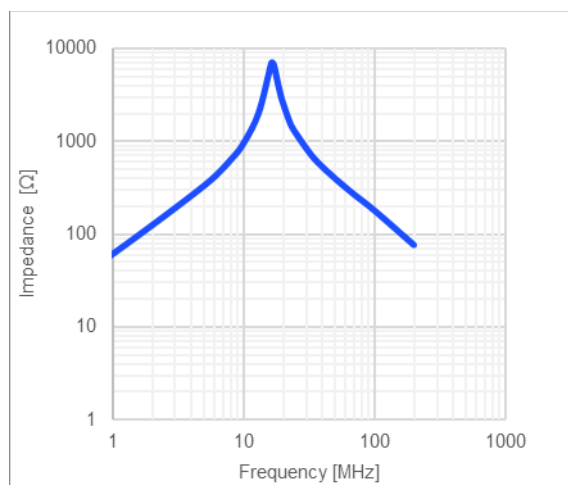
Temperature Rise vs. Current



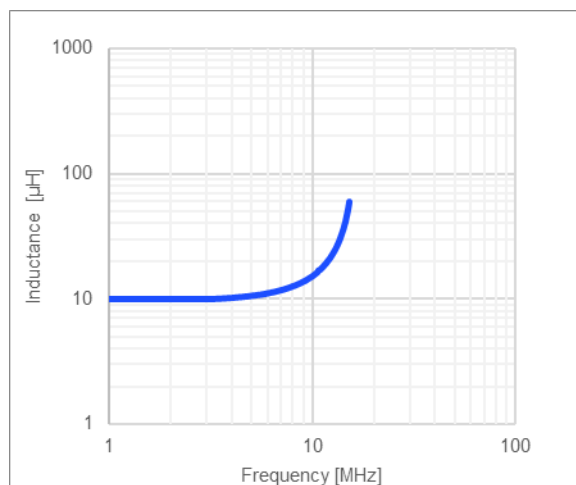
Inductance vs. Current



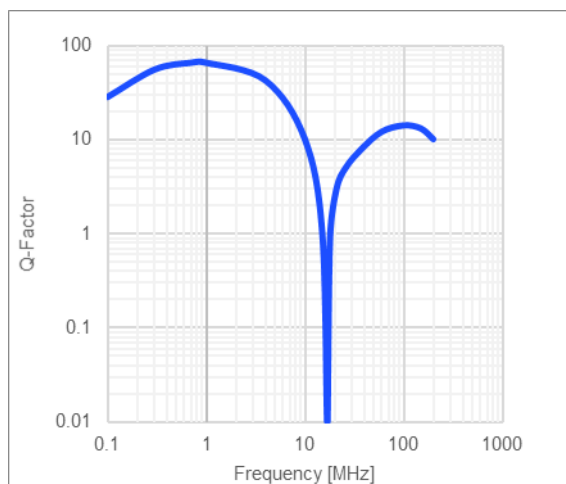
Impedance vs. Frequency



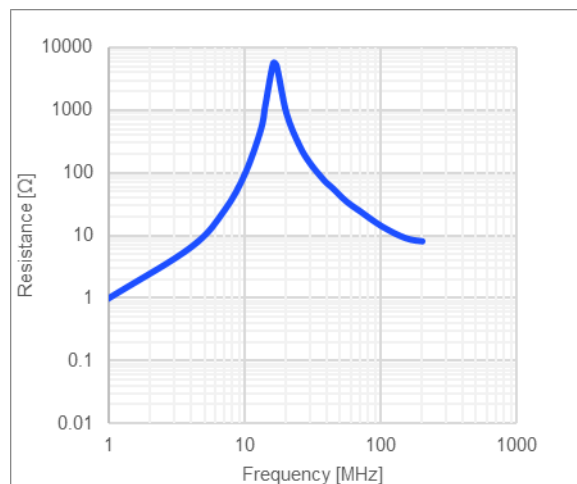
Inductance vs. Frequency



Quality Factor vs. Frequency



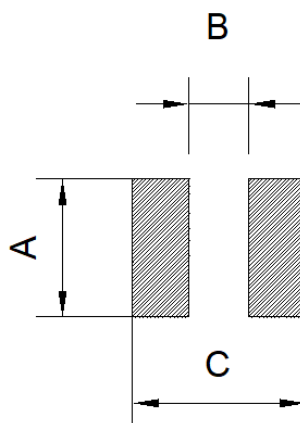
AC Resistance vs. Frequency



LAND PATTERN

Dimensions

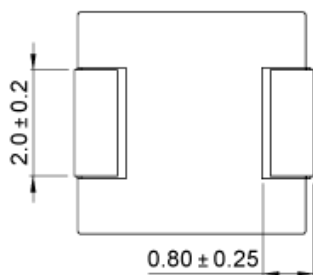
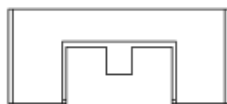
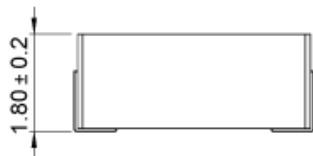
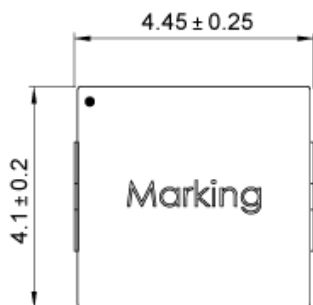
A	2.50 ref.
B	2.20 ref.
C	5.20 ref. (unit in mm)



PRODUCT PACKAGE AND DIMENSIONS

Dimensions

(unit in mm)



TOP MARKING

Marking

Start of Winding	· (dot)
Inductance Code	100

ORDERING INFORMATION

Part Number	$L^{(1)}$	R_{DC}	$I_R^{(2)}$	$I_{SAT\ 25^\circ C}^{(3)}$	$I_{SAT\ 100^\circ C}^{(4)}$
	typ (μH)	typ (mΩ)	typ (A)	typ (A)	typ (A)
MPL-AY4020-5R6	5.6	97	2.45	2.6	2.6
MPL-AY4020-6R8	6.8	129	2.20	2.4	2.4
MPL-AY4020-8R2	8.2	136	2.10	2.1	2.1
MPL-AY4020-100	10	163	1.90	2	2

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(2) Rated Current	Rated current will cause the coil temperature rise ΔT of 40K <i>I_R measured with the inductor soldered in a single-layer PCB. Copper layer thickness 35μm Cu / PCB size 30x50mm. Temperature behavior dependent on circuit design, PCB layout, proximity to other components, and trace dimensions and thickness.</i>
(3) Saturation Current $_{25^\circ C}$	Saturation current will cause L to drop from 30% at 25°C ambient temperature
(4) Saturation Current $_{100^\circ C}$	Saturation current will cause L to drop from 30% at 100°C ambient temperature
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